

ITEM :

CRYSTAL OSCILLATOR

TYPE :

DSB321SDN

NOMINAL FREQUENCY :

14.7456MHz

SPEC No. :

1XTW14745MDA

Please acknowledge receipt of this specification by signing and returning a copy to us.

	RECEIPT
DATE	
RECEIVED	(signature) (name)



Sakamoto ENG.

- 1. Device Name
- 2. Model Name DSB321SDN
- 3. Nominal Frequency 14.7456 MHz

TCXO

0.03g max.

4. Mass

5. Absolute Maximum Ratings

	Item	Symbol		Rating			
1	Supply Voltage	Vcc		-0.3~+4.6		V	
2	Storage Temperature Range	T_ _{STG}		-40~+85		°C	
6. Re	6. Recommended Operating Conditions						
	Item	Symbol	min.	typ.	max.	unit	
1	Supply Voltage	V _{CC}	+3.13	+3.3	+3.47	V	
2	Load Impedance (resistance part)	$L_{OAD}R$	9	10	11	kΩ	
	(parallel capacitance)	L _{OAD} _C	9	10	11	pF	
3	Operating Temperature Range	T_ _{OPR}	-40	-	+85	°C	

7. Electrical Characteristics

		(T _A =-40~+85°C, L _{OAD} _R//C=	=10kΩ//10pF,	V _{CC} =+3.	3V, unles	s otherwise	noted)
	Item	Conditions	Limits			unit	Notes
	item	Conditions	min.	typ	max.	unit	Notes
1	Current Consumption		-	-	+2.0	mA	
2	Output Level		0.8	-	-	V_{P-P}	1
3	Symmetry	GND level (DC cut)	40/60	I	60/40	%	
4	Harmonics		-	-	-5	dBc	1
5	Frequency Stability 1.Tolerance	After 2 times reflow Ref. to nominal frequency	-	-	±1.5	ppm	2,3
	2.vs Temperature	T_A =-30~+80°C Ref. to frequency (T_A =+25°C)	-	-	±0.5	ppm	
		T_A =-40~+85°C Ref. to frequency (T_A =+25°C)	-	-	±1.0	ppm	L
	3.vs Supply Voltage	V _{CC} =+3.3V±0.17V	-	I	±0.2	ppm	
	4.vs Load Variation	L _{OAD} _R//C=(10kΩ//10pF)±5%	-	I	±0.2	ppm	
	5.vs Aging	T _A =Room ambient	-	I	±0.02	ppm/day	4
		T _A =Room ambient	-	I	±1.0	ppm/year	4
6	Start Up Time	@90% of final Vout level	-	I	2.0	ms	
7	SSB Phase Noise	Relative to f0 level offset 10Hz	-	I	-80	dBc/Hz	
		Relative to f0 level offset 100Hz	-	I	-110	dBc/Hz	
		Relative to f0 level offset 1kHz	-	-	-130	dBc/Hz	
		Relative to f0 level offset 10kHz	-	-	-140	dBc/Hz	
		Relative to f0 level offset 100kHz	-	-	-143	dBc/Hz	
		Relative to f0 level offset 1MHz	-	-	-145	dBc/Hz	

Notes

1. Clipped sine wave (DC-coupled)

2. T_A=+25°C

3. Please leave after reflow in 2h or more at room ambient.

4. after 1h of operation

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	Item	Description		Reg	uirements	-	
1	Drop	Natural drop (On concrete)					
		Mounting on the set or test fixture.(To	tal weight 100g)				
		Height : 150cm	tal weight roog/				
		Direction : X,Y,Z, 6directions		df/f=<±1.0pp	m		
		Test cycle : 3cycles					
		Reference specification : EIAJ-ED-47	024 Method5				
2	Vibration	Sweep range : 10~2000Hz					
2	VIDIATION	Sweep speed : 20min/cycle					
		Amplitude : 1.5mm (10~55Hz)					
		Acceleration : 200m/s ² (55~2000Hz)		df/f=<+0 Epg			
				df/f=<±0.5pp	////		
		Direction : X,Y,Z, 3directions					
		Test cycle : 120cycles					
	Ohaali	Reference specification : IEC 60068-2 Acceleration : 1000m/s ²	2-0				
3	Shock						
		Direction : X,Y,Z, 6directions					
		Duration : 6ms		df/f=<±0.5pp	om		
		Test cycle : 3cycles/each directions					
		Reference specification : IEC 60068-2	2-27				
4	PCB bend	PWB : t=1.6mm					
	strength	Pressure speed : 1.0mm/s		df/f=<±0.5pp			
		Bend width : $1 \rightarrow 2 \rightarrow 3$ mm		No visible da	•		
		Duration : 10±1s	No leak dam	lage.			
	A 11	Reference specification : IEC 60068-2	2-21 Ue1				
5	Adherence nature	PWB : t=1.6mm					
		Direction : X,Y, 2directions		df/f=<±0.5pp			
		Pressure : 10N		No visible da	-		
		Duration : 10±1s		No leak dam	lage.		
		Reference specification : IEC 60068-2	2-21 Ue3				
6 Package strength		Pressure : 10N		df/f=<±0.5ppm			
		Duration : 10±1s	No mechanical damage.				
	_	Reference specification : IEC 60068-2		No leak dam	lage.		
7	Gross leak	It is immersed for 3min into +125±5°C					
		Chlorofluorocarbon (CFCs) liquid. No continuous air l				6.	
		Reference specification : IEC 60068-2					
8	Fine leak	It shall be measured by the helium lea		or			
		after pressurization for 60min by the p		$1 \cos t \sin 1 0 \times 10^{-9} \text{Da m}^{3}$			
		of $(3.92\pm0.49) \times 10^5$ Pa in a helium ga	s atmosphere.	Less than 1.		5.	
		Reference specification : IEC 60068-2	2-17				
9	Solderability					solde	
		Duration : 3±0.3s		shall cover a	minimum of	95%	
		Reference specification : IEC 60068-2	2-58	of the surfac	e being imme	rsed.	
0	Resistance to	1) Solder iron method					
	soldering heat	Bit size : $B(\varphi 3)$ Bit temperature : +3	50±10°C	df/f=<±0.5pp	m		
	C C	Duration : 3+1/-0s /each terminal		dV _{OUT} =<±0.2			
		It shall be measured after 2h at room	temperature,	No visible da	amage.		
		humidity. Reference specification : IE			U		
		2) Reflow					
		In refer to temperature profile shown i	n clause13.	df/f=<±1.0pp	m		
		Test cycle : 3cycles		dV _{OUT} =<±0.2			
		It shall be measured after 2h at room	temperature	No visible da			
		humidity. Reference specification : IE			June		
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11. Environmental Characteristics All test is performed after 3 times reflow (Clause13) Item Description Requirements 1 Low temperature Temperature : -40±3°C df/f=<±1.0ppm storage $dV_{OUT} = < \pm 0.2V_{P-P}$ Duration: 1000h It shall be measured after 2h at room temperature. The electrical characteristics humidity. Reference specification : IEC 60068-2-1 Ab are satisfied. 2 High temperature Temperature : +85±2°C df/f=<±1.0ppm storage Duration: 1000h $dV_{OUT} = < \pm 0.2V_{P-P}$ The electrical characteristics It shall be measured after 2h at room temperature, humidity. Reference specification : IEC 60068-2-2 Bb are satisfied. 3 Humidity Temperature : +85±2°C df/f=<±1.0ppm R.H. 85±5% dV_{OUT}=<±0.2V_{P-P} Duration: 1000h The electrical characteristics It shall be measured after 2h at room temperature. are satisfied. humidity. Reference specification : IEC 60068-2-3 HTB 4 Temperature : +85±2°C df/f=<±1.0ppm Duration: 1000h dV_{OUT}=<±0.2V_{P-P} BIAS : Max value of supply voltage The electrical characteristics It shall be measured after 2h at room temperature, are satisfied. humidity. Reference specification : IEC 60068-2-2 Bb 5 THB Temperature : +40±2°C R.H. 90~95% df/f=<±1.0ppm dV_{OUT}=<±0.2V_{P-P} Duration: 1000h The electrical characteristics BIAS : Max value of supply voltage are satisfied. It shall be measured after 2h at room temperature, humidity. Reference specification : IEC 60068-2-3 6 Thermal shock Thermal shock : $-40\pm3^{\circ}C$: 0.5h \Leftrightarrow $+85\pm2^{\circ}C$: 0.5h df/f=<±1.0ppm Test cycle : 200cycles dV_{OUT}=<±0.2V_{P-P} Shift time : 2~3min The electrical characteristics It shall be measured after 2h at room temperature, are satisfied. humidity. Reference specification : IEC pub.68-2-14.Na 7 ESD Model : Machine Model (MM) V=±200V (C=200pF, R=0Ω) df/f=<±1.0ppm Number of times : 3times $dV_{OUT} = < \pm 0.2V_{P-P}$ Each terminal except common terminal. The electrical characteristics (Connect to test terminal) are satisfied Reference specification : EIA/JESD22-A115 Model : Human Body Model (HBM) V=±2000V (C=100pF, R=1500Ω) df/f=<±1.0ppm Number of times : 3times dV_{OUT}=<±0.2V_{P-P} The electrical characteristics Each terminal except common terminal. are satisfied. (Connect to test terminal) Reference specification : EIA/JESD22-A114 TITLE Remark DSB321SDN TYPE SPECIFICATION Date Spec. No. Page Rev. 2016/02/25 4/13





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15. Packing Condition

- 15.1 Taping package
 - (1) Emboss tape format and dimensions See Fig.1
 - (2) Quantity on reel
 - 2000pcs. max. / reel (3) Taping specification
 - See Fig.2
 - No lack of a product.
 - (4) Reel specification
 - See Fig.3 (5) Taping material list
- See right table.

15.2 Packing

- The products packed in the antistatic bag.
- *Moisture sensitivity level : IPC/JEDEC Standard J-STD-033 / Level 1
- No dry pack required and baking after re-storage is unnecessary.

15.3 Packing box

Max 10 reels/packing box. However, in the case of less than 10 reels, It is contained by any boxes. The space in a box is fill up with a cushion.

15.4 Label detail

A Lot label is put on a reel and a shipping label and Pb-Free label is put on a packing box.

Lot label		Shipping label		 Pb-free Label
TYPE SPEC NO. PARTS NO LOT NO. FREQ.	(Model Name) (Spec. Number) (User's Parts Number) (Lot Number) (Nominal Frequency)	ITEM SPEC DELIVERY DATE Q'TY NOTES	(Model Name) (Spec. Number) (Delivery Date) (Quantity) (User's Parts Number)	Pb
Q'TY KDS	(Quantity) DAISHINKU CORP.	DAISHINKU CORF		Pb-free

Lot label (Example)

TYPE	XXXXXXXX
SPEC NO.	XXXXXXXXXXXX
PARTS NO.	xxxxxxxxxxxx
LOT NO.	XXXXXXXXX
FREQ	XX.XXX MHz
Q'TY	2000pcs.
KDS 🔅	Made in Japan

Formation of a lot number

e.g. AH6101001			
<u> </u>	<u> H </u>	6101	_001_
Manufacturing site code	Product code	year/ month/ day	Serial No.

Taping material List

Emboss : PS (Conductivity)

Reel : PS (Conductivity)

Cover Tape : PET + Olefin Resin (Conductivity)

The notation method of a manufacture year, month, and day. (4digits alphanumeric character)

YMDD		(4digi	ts) e	e.g.) 20)1 <u>6</u> /0 <u>1</u>	<u>/01</u> →	<u>6101</u>						
<u>Y</u>		Year	1	1digit (Last digit of Year)									
<u>M</u>		Month	ר ר	1digit alphanumeric symbol									
DD			Day	2	digits	numer	ical ch	aracte	ers of d	ay			
	Month	Jan.	Feb.	Mar.	Apr.	May.	Jun.	Jul.	Aug.	Sep.	Oct.	Nov.	Dec.
	Symbol	1	2	3	4	5	6	7	8	9	0	Ν	D

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Lot Label	Air Cushion		
Antistatic Bag	Pb-free Label		7
The product is packed up with the method which d	oes not break in the handling by a shippi	ng agent.	
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16. Notes on mounting and handling

16.1 Storage environment

- (1) The temperature and humidity of a storage place, Please give +5~+40°C and 40~85% as a standard.
- (2) Please use this product within one year from the packing label date of issue.
- (3) Please avoid the place which generates corrosive gas, and the place with much dirt.
- (4) Please keep it in a place with little temperature change.
- Dew condensation arises owing to a rapid temperature change and solderability becomes bad.
- 16.2 Be cautions to static electricity and high voltage.
- 16.3 This product has sufficient durability to fall and vibration. However, conditions may change to the fall after mounting to a PWB, and vibration. When you should drop on a floor the PWB which mounted the product or too much shock is added. Please use after a performance check.
- 16.4 Please check that the curvature of the substrate at the time of substrate cutting does not affect product. Moreover, especially when a product is near the position of a PWB guide pin, and the position of PWB break, be careful.
- 16.5 The part concerned does not correspond to washing.

16.6 Please repair at +260°C in 10s with hot air or +350°C in 5s with solder Iron.

17. Mandatory control

17.1 Ozone-depleting substance

It regulates by the U.S. air purifying method (November, 1990 establishment). ODS of CLASS1 and CLASS2 is not contained or used.

17.2 PBDE, PBBs

PBDE, PBBs are not contained into all the material currently used for this product.

17.3 RoHS

Following material restricted by RoHS (2011/65/EU) is not included or used. Lead, mercury, cadmium, hexavalent, chromium, PBB and PBDE.

17.4 Law Concerning Examination and Regulation of Manufacture, etc. of Chemical Substances

All the material currently used for this product is based on "Law Concerning Examination and Regulation of Manufacture, etc. of Chemical Substances". It is a registered material.

17.5 Lead

Leads, such as solder, are not used for this product. (Lead Free)

17.6 About the existence of silver and mercury use

The silver of very small quantity is contained in the conductive adhesives used for adhesion of Blank. Moreover, mercury is used. It does not get down.

18. The country of origin / factory name / address

Country of origin:	Japan
Factory name:	DAISHINKU Corp. Tottori Production Div.
Address:	7-3-21 Wakabadai minami, Tottori 689-1112

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2016-0181 REVERSION RECORD

Rev. No.	Date	Reason	Contents	Approved	Checked	Drawn
-	2016/01/25	-	Initial Release	H.Takase	S.Sakamoto	M.Kashihara